DC-DC Converter (-20V, -1.0A)

RTF010P02

Features

- 1) Low on-resistance. ($80m\Omega$ at 2.5V)
- 2) High power package.
- 3) High speed switching.
- 4) Low voltage drive. (2.5V)

Applications

DC-DC converter

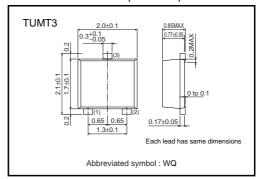
●Structure

Silicon P-channel MOS FET

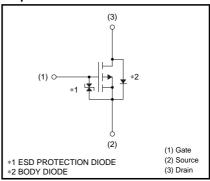
Packaging specifications

	Package	Taping		
Туре	Code	TR		
	Basic ordering unit (pieces)	3000		
RTF010P02	0			

●External dimensions (Unit : mm)



●Equivalent circuit



● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit	
Drain-source voltage		VDSS	-20	V	
Gate-source voltage		Vgss	±12	V	
Drain current	Continuous	lσ	±1	Α	
	Pulsed	IDP *1	±4	Α	
Source current	Continuous	Is *1	-0.4	Α	
(Body diode)	Pulsed	Isp	-4	Α	
Total power dissipation		P _D *2	0.8	W	
Channel temperature		Tch	150	°C	
Range of Storage temperature		Tstg	-55 to +150	°C	
Range of Storage temperature		rsig	-55 tO +150	L L	

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	∞A	V _{GS} =±12V, V _{DS} =0V
Drain-source breakdown voltage	V _(BR) DSS	-20	-	_	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	_	_	-1	∞A	Vps= -20V, Vgs=0V
Gate threshold voltage	VGS (th)	-0.7	_	-2.0	V	V _{DS} = -10V, I _D = -1mA
Static drain-source on-state resistance	R _{DS (on)}	-	280	390	mΩ	I _D = -1A, V _G S= -4.5V
		-	310	430	mΩ	I _D = -1A, V _G S= -4V
		_	570	800	mΩ	I _D = -0.5A, V _G S= -2.5V
Forward transfer admittance	Y _{fs} *	0.7	-	_	S	$V_{DS} = -10V, I_{D} = -0.5A$
Input capacitance	Ciss	-	150	_	pF	V _{DS} = -10V
Output capacitance	Coss	-	20	_	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	20	_	pF	f=1MHz
Turn-on delay time	t d (on) *	_	9	_	ns	ID= -0.5A
Rise time	tr *	_	8	_	ns	VDD≒ -15V
Turn-off delay time	t _{d (off)} *	-	25	_	ns	V _{GS} = -4.5V R _L =30Ω
Fall time	t _f *	_	10	_	ns	RGS= 10Ω
Total gate charge	Qg	_	2.1	_	nC	V _{DD} ≒−15V RL≒15Ω
Gate-source charge	Qgs	_	0.5	_	nC	$V_{GS}=-4.5V$ RGS= 10Ω
Gate-drain charge	Q _{gd}	_	0.5	_	nC	I _D = -1A

Body diode characteristics (source-drain characteristics)

Body diede characteristics (course drain characteristics)						
Forward voltage	VSD	_	_	-1.2	V	I _S = -0.4A, V _{GS} =0V



^{*1} Pw≤10≪s, Duty cycle≤1% *2 Mounted on a ceramic board

Electrical characteristic curves

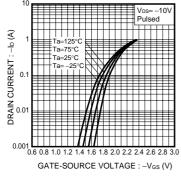


Fig.1 Typical Transfer Characteristics

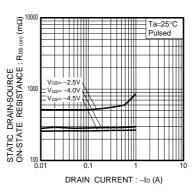


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

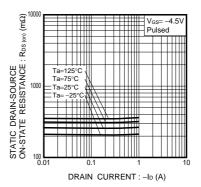


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

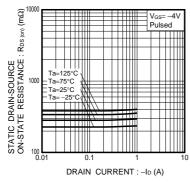


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

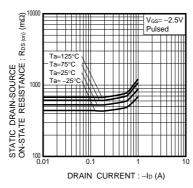


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

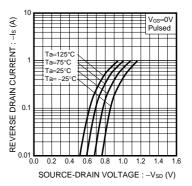


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

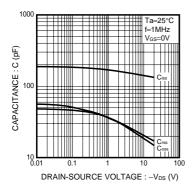


Fig.7 Typical Capacitance vs. Drain-Source Voltage

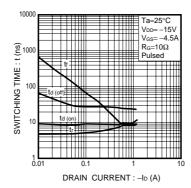


Fig.8 Switching Characteristics

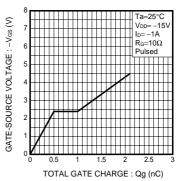


Fig.9 Dynamic Input Characteristics

●Measurement circuits

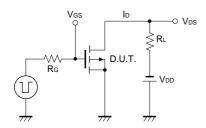


Fig.10 Switching Time Measurement Circuit

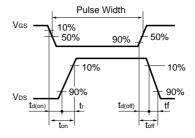


Fig.11 Switching Waveforms

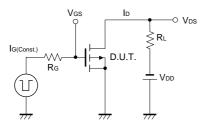


Fig.12 Gate Charge Measurement Circuit

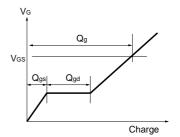


Fig.13 Gate Charge Waveforms

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